Ceramic Plate Series Thermoelectric Cooler

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The CP10-254-06-L1-EP-W4.5 is a high-performance and highly reliable standard Thermoelectric Cooler. Assembled with Bismuth Telluride semiconductor material and thermally conductive Aluminum Oxide ceramics. It has a maximum Qc of 51 Watts when $\Delta T = 0$ and a maximum ΔT of 70.5 °C at Oc = 0.

- **Features**
- Compact geometric sizes

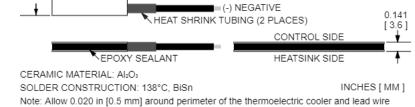
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- DC Operation
- RoHS-compliant

2.362 [60.0

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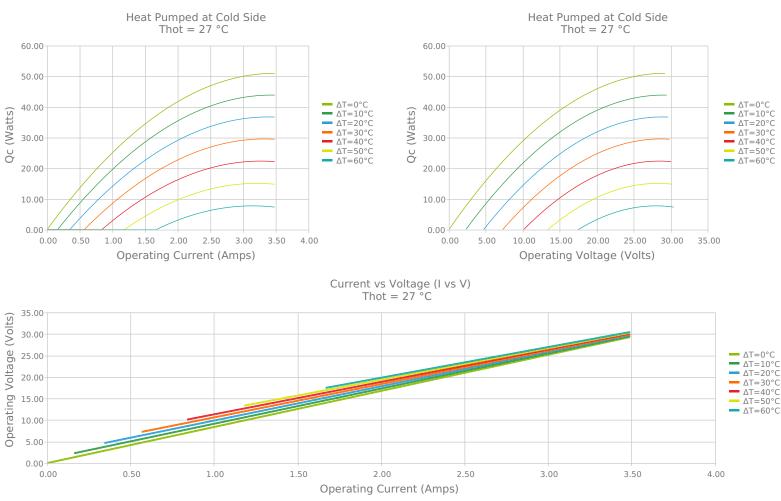
- **Applications**
- Thermoelectric Coolers for Reagent Storage • Thermoelectric Coolers for Handheld Cosmetic Lasers • Cooling for Centrifuges • Heads-Up Displays, Imaging Sensors • Peltier Cooling for Machine Vision AWG 24 PVC STRANDED 4.5 [114] LENGTH = (+) POSITIVE

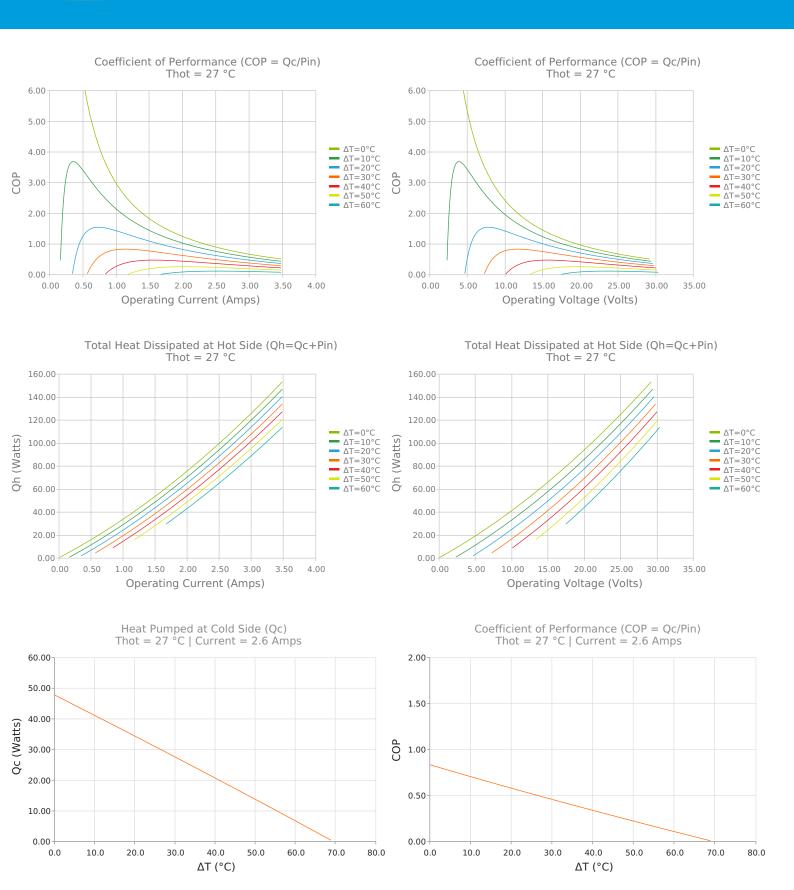


attachment to accommodate sealant

ELECTRICAL AND THERMAL PERFORMANCE

For maximum performance, be sure to orient the CONTROL side of the TEC against the application to be managed and the HEATSINK side against the heat sink or other heat rejection method. The CONTROL side is always opposite the side with lead attachments. Lead attachment is a passive heat loss and less impactful if located on the side that attaches to the heat exchanger.





SPECIFICATIONS*

Hot Side Temperature	27.0 °C	35.0 °C	50.0 °C
$Qcmax (\Delta T = 0)$	51.0 Watts	52.5 Watts	55.3 Watts
ΔTmax (Qc = 0)	70.5°C	73.5°C	78.8°C
lmax (I @ ΔTmax)	3.1 Amps	3.1 Amps	3.0 Amps
Vmax (V @ ΔTmax)	27.7 Volts	28.8 Volts	30.8 Volts
Module Resistance	8.38 Ohms	8.73 Ohms	9.39 Ohms
Max Operating Temperature	80 °C		
Weight	17.0 gram(s)		

* Specifications reflect thermoelectric coefficients updated March 2020

FINISHING OPTIONS

Suffix	Thickness	Flatness / Parallelism	Hot Face	Cold Face	Lead Length
L1	3.581 ±0.025 mm 0.141 ± 0.0010 in	0.025 mm / 0.025 mm 0.001 in / 0.001 in	Lapped	Lapped	114.3 mm 4.50 in

SEALING OPTIONS

Suffix	Sealant	Color	Temp Range	Description
EP	Ероху	Black	-55 to 150°C	Low density syntactic foam epoxy encapsulant

NOTES

- 1. Max operating temperature: 80°C
- 2. Do not exceed Imax or Vmax when operating module
- 3. Reference assembly guidelines for recommended installation
- 4. Solder tinning also available on metallized ceramics

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